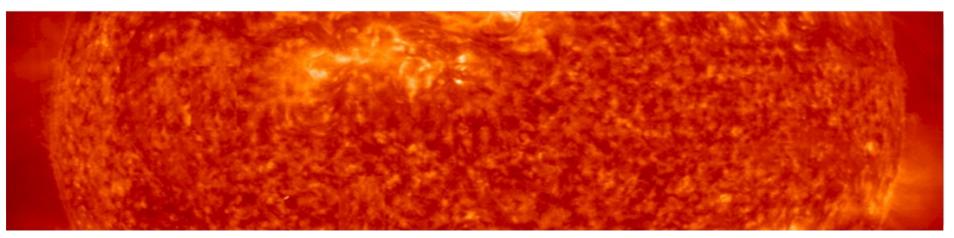




Initial characterization of MPA CVD diamond to be investigated by fracture toughness measurements

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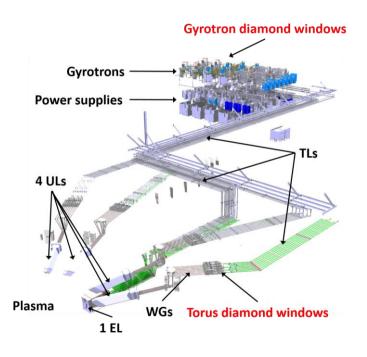


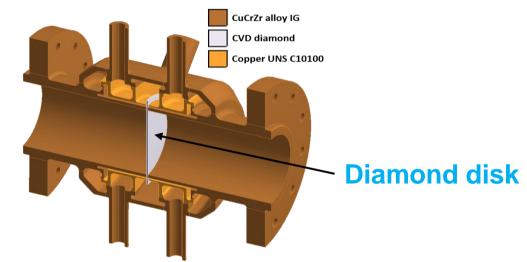
Outline

- Context
- MPA CVD diamond and properties
- Experimental setup for fracture toughness
- Characterization techniques for the samples
- Numerical analyses
- Summary and outlook

Context - EC H&CD system (ITER)

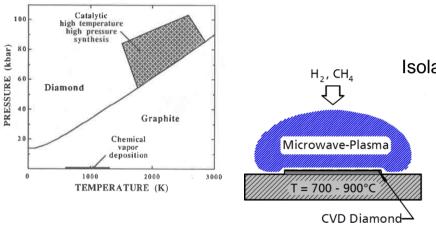


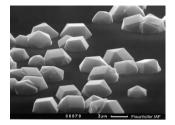




- Fundamental <u>safety role</u> of diamond disks in fusion reactors
- Failure to fracture is the main failure mode for the disks

MPA CVD diamond





Polycrystalline plate



Isolated crystallites (nucleation)

- $t = n \frac{\lambda_m}{2}$
- Diamond growth by Microwave Plasma Assisted (MPA) Chemical Vapour Deposition (CVD)
- Unique solution for MW-class, CW operation
- Growth rate of 0.1-10 µm/h
- Disk resonant thickness t = 1.11 mm (ITER)



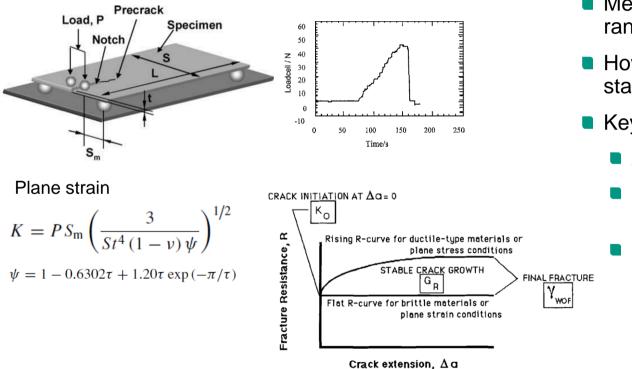
Fracture toughness (K_{IC}) of diamond - literature

Fractur toughne (MPa m	ess $ $ Error $	Type of diamond	Thickness (µm)	Shape	Dimensions (mm)	# of samples	Test method	Code	Papers no.	Year
6.3	-	MPA CVD diamond	150 to 200	Disk	ø 25	2	Tensile test	E-399	10, 1	1995
5.6	0.4	MPA CVD diamond	150 to 200	-	-	8	Indentation		10	1995
5.3	1.3	MPA CVD diamond	400	-	-	11	Indentation		6	1991
8.7	0.3	MPA CVD diamond	880	Rectangular	13 x 18	-	Double torsion		8	1998
8.3	0.4	MPA CVD optical diamond	1000	Rectangular	13 x 18	5	Double torsion		3	2004
8.5	1	MPA CVD mechanical diamond	1000	Rectangular	13 x 18	2	Double torsion		3	2004
6.5	1.2	Arc-discharge CVD diamond	244 (aver.)	Disk	ø7 to ø16	5	Ball on ring		5	1992
7.6	1.8	Arc-discharge CVD diamond	244 (aver.)	Disk	-	4	Indentation		5	1992
8	-	Arc-discharge CVD diamond	485	Rectangular	2 x 10	9	Three-point	E-399	7	2000
9.2	-	Arc-discharge CVD diamond	485	Rectangular	2 x 10	8	Three-point	E-399	7	2000
4.6	-	Arc plasma jet CVD	300 to 700	Disk	ø8	-	Ball on ring		13	1998
6	-	CVD diamond	300	-	-	-	Indentation		2	1994
6.8	1.1	Arc plasma jet/hot filament CVD	450	Rectangular	2,5 x 12	3	Three-point	E-399	12	2001
3.4	-	Natural diamond type la and Ila	-	-	-	9	Indentation		4	1981
13	-	PDC - cobalt phase	700 (aver.)	Rectangular	~15 x 30	5	Double torsion		11	1994

5

Double torsion (DT) method for measurement





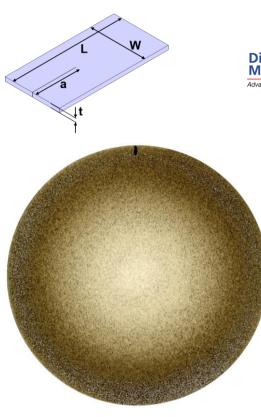
- Method applied to a very extensive range of materials
- However, it has not been standardized yet
- Key features:
 - A relatively simple method
 - K_I independent of crack lenght for a certain range
 - Ideal method for opaque materials

A. Shyam et al., J. Mater Sci 41, 2006

Diamond samples

	t (mm)	W (mm)	L (mm)	L/W	W/t
Big samples	1.11	15	30	2.0	13.5
Small samples	1.11	12	22	1.8	10.8

- Two diamond disks fabricated at end 2023: optical and thermal grade
- High cost of diamond is the limiting factor for a good statistics in the experimental measurements
- Preliminary samples available for initial characterization



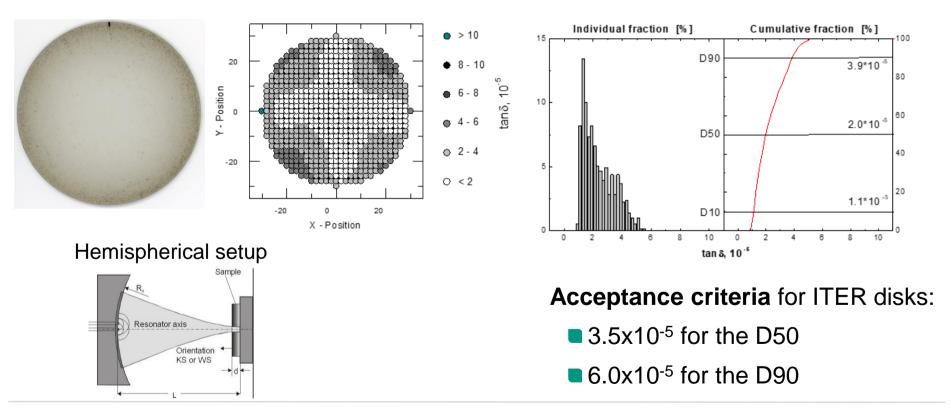




Thermal disk Ø 150 mm Optical disk Ø 80 mm



Loss tangent measurements – optical grade



X-ray diffraction (XRD) measurements



Objectives:

- XRD pattern
- Texture measurements
- Residual stress analysis

Growth Side (GS)

Thermal quality









Nucleation Side (NS)

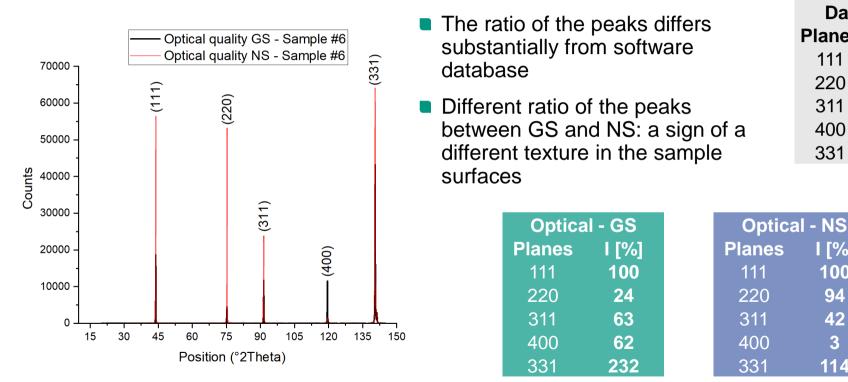




Empyrean diffractometer (Malvern Panalytical)

XRD pattern – optical grade





Database				
Planes	l [%]			
111	100			
220	25			
311	16			
400	8			
331	16			

| [%]

100

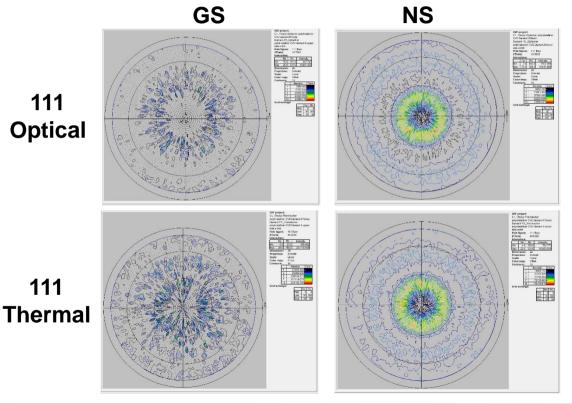
94

42

3

114

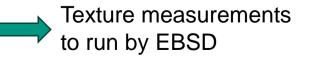
XRD texture – optical quality





 Texture measurements were done in a 2 mm x 2 mm central area in the samples

- It was not possible to draw a clear conclusion
- No crystallographic direction is however perfectly parallel to the diamond growth direction
- As expected, circular symmetry occurs

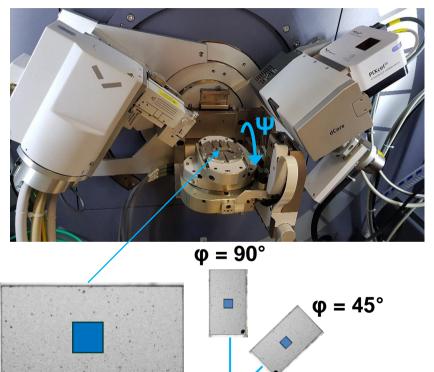


XRD residual stress analysis - I



- Determination of macroscopic in-plane residual stresses by sin²Ψ method
- Sampling area of 3 mm x 3 mm
- Cu K_{α} radiation
- (331) lattice plane selected corresponding to 2θ = 140.6°
- φ 3 directions around surface normal
- Ψ 16 sample tilt angles from 0 to 60°
- Modified Lorentzian shape function
- Isotropic elastic constants from database

$$\sigma_{\phi} = \left(\frac{E}{1+\nu}\right)_{(hkl)} \frac{1}{d_{\phi o}} \left(\frac{\partial d_{\phi \psi}}{\partial \sin^2 \psi}\right)$$



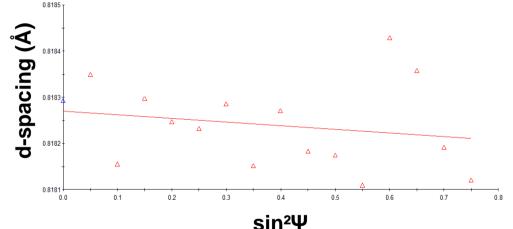
Institute for Applied Materials

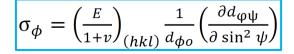
 $\boldsymbol{\omega} = \mathbf{0}^{\circ}$

XRD residual stress analysis - II



- Determination of macroscopic in-plane residual stresses by sin²Ψ method
- Sampling area of 3 mm x 3 mm
- Cu K_{α} radiation
- (331) lattice plane selected corresponding to 2θ = 140.6°
- φ 3 directions around surface normal
- Ψ 16 sample tilt angles from 0 to 60°
- Modified Lorentzian shape function
- Isotropic elastic constants from database





XRD residual stress analysis - III



- First XRD residual stress measurements, to be consider as preliminary
- Average macro-residual stress appears to vary from few MPa to ~200 MPa, both in tensile and compression state
- Large value of standard deviation (maybe influence of texture, columnar growth as observed in Harker, 1994)
- Maybe triaxial stress state?
- Further investigations on the macroresidual stress state are ongoing

	NS σ (MPa)	GS σ (MPa)	Ф (°)
Optical	-8.8 ± 47.9	74.7 ± 112	0
grade	93.9 ± 45.9	-114 ± 88.7	45
	-67.5 ± 34.6	-84.6 ± 110	90
,			
	NO	00	

Ф (°)	GS σ (MPa)	NS σ (MPa)	
0	-161 ± 88.6	25 ± 71.1	Thermal
45	-26.9 ± 142	-47.2 ± 56.1	grade
90	193 ± 122	-32.8 ± 90.5	

Other characterization techniques



Raman

- Test measurements at ISSP, Riga (LV)
- Measurements planned at KIT

Electron Backscatter Diffraction (EBSD)

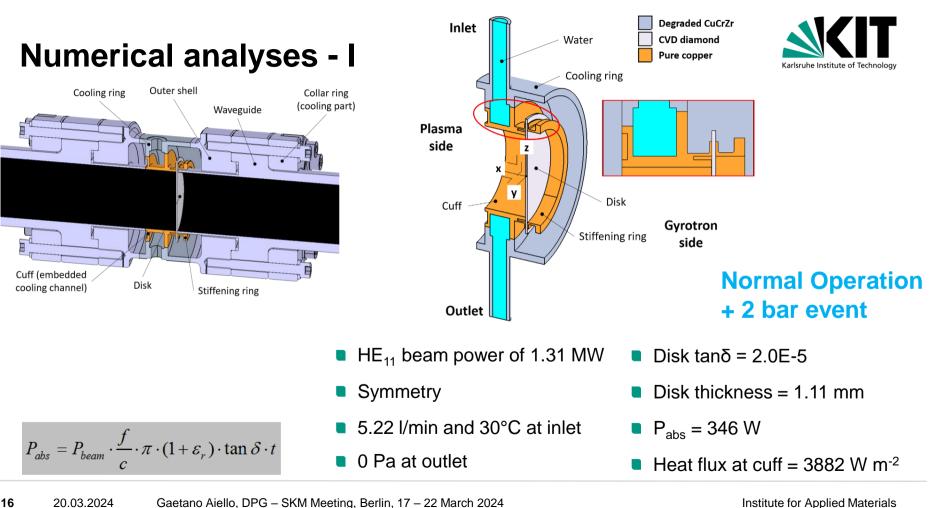
Data evaluation on going

Auger / XPS

Measurements on going

Optical quality

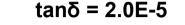


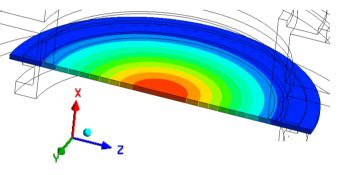




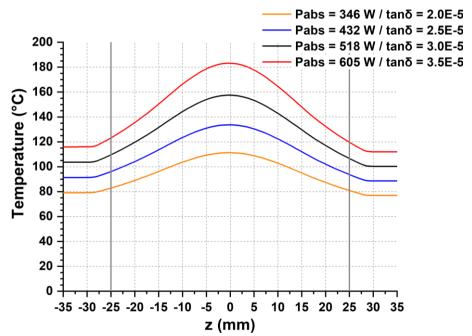
Numerical analyses - II

[°C] 1.113e+02 1.079e+02 1.044e+02 1.010e+02 9.752e+01 9.408e+01 9.063e+01 8.718e+01 8.374e+01 8.029e+01 7.684e+01



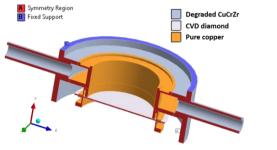


- Maximum T in the disk lower than design safe limit of 250 °C
 - Sensitivity study for loss tangent
 - Robust window design from thermal perspective

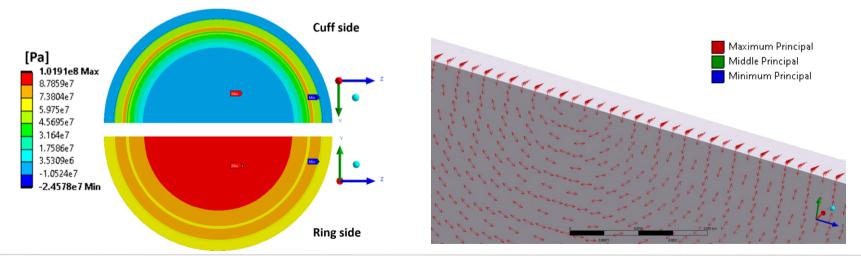


Numerical analyses - III





- Worst case: Normal Operation + 2 bar event on cuff side
- Maximum stress in the disk lower than 150 MPa allowable limit
- Vector plots of the maximum principal stresses



Summary & outlook



- A deeper mechanical characterization of MPA CVD diamond regarding its main failure mode is required
- The method for fracture toughness measurement was selected and characterization of the diamond samples have been started
- Numerical analyses for worst load scenario of the diamond disks were performed
- Continue characterization of samples
- Generate drawings of the setup and carry out the experiments



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